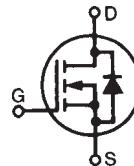


PolarHV™ HiPerFET Power MOSFET

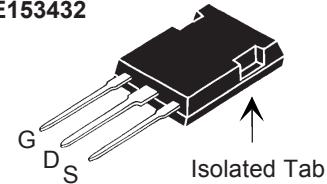
(Electrically Isolated Back Surface)

N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Diode



V_{DSS}	=	600	V
I_{D25}	=	20	A
$R_{DS(on)}$	\leq	200	mΩ
t_{rr}	\leq	200	ns

ISOPLUS247 (IXFR)
 E153432



G = Gate D = Drain
S = Source

Symbol	Test Conditions	Maximum Ratings		
V_{DSS}	$T_J = 25^\circ C$ to $150^\circ C$	600	V	
V_{DGR}	$T_J = 25^\circ C$ to $150^\circ C$; $R_{GS} = 1 M\Omega$	600	V	
V_{GSS}	Continuous	± 30	V	
V_{GSM}	Transient	± 40	V	
I_{D25}	$T_c = 25^\circ C$	20	A	
I_{DM}	$T_c = 25^\circ C$, pulse width limited by T_{JM}	80	A	
I_{AR}	$T_c = 25^\circ C$	36	A	
E_{AR}	$T_c = 25^\circ C$	50	mJ	
E_{AS}	$T_c = 25^\circ C$	1.5	J	
dv/dt	$I_s \leq I_{DM}$, $di/dt \leq 100 A/\mu s$, $V_{DD} \leq V_{DSS}$, $T_J \leq 150^\circ C$, $R_G = 2 \Omega$	20	V/ns	
P_D	$T_c = 25^\circ C$	208	$^\circ C$	
T_J		-55 ... +150	$^\circ C$	
T_{JM}		150	$^\circ C$	
T_{stg}		-55 ... +150	$^\circ C$	
T_L	1.6 mm (0.062 in.) from case for 10 s	300	$^\circ C$	
T_{SOLD}	Plastic body for 10 s	260	$^\circ C$	
V_{ISOL}	50/60 Hz, RMS, 1 minute	2500	V \sim	
F_c	Mounting force	20..120/4.6..27	N/lb	
Weight		5	g	

Features

- | Silicon chip on Direct-Copper-Bond substrate
 - High power dissipation
 - Isolated mounting surface
 - 2500V electrical isolation
- | International standard package
- | Fast recovery diode
- | Unclamped Inductive Switching (UIS) rated
- | Low package inductance
 - easy to drive and to protect

Symbol	Test Conditions ($T_J = 25^\circ C$, unless otherwise specified)	Characteristic Values			Advantages
		Min.	Typ.	Max.	
BV_{DSS}	$V_{GS} = 0 V$, $I_D = 250 \mu A$	600		V	
$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 4 mA$	3.0		5.0 V	
I_{GSS}	$V_{GS} = \pm 30 V$, $V_{DS} = 0 V$			$\pm 100 nA$	
I_{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$			25 μA	
				250 μA	
$R_{DS(on)}$	$V_{GS} = 10 V$, $I_D = I_T$ (note 1) Pulse test, $t \leq 300 \mu s$, duty cycle $d \leq 2 \%$			200 mΩ	

Symbol Test Conditions

Characteristic Values

(T_J = 25°C, unless otherwise specified)

Min. Typ. Max.

g_{fs}	V _{DS} = 20 V; I _D = I _T , pulse test	25	40	S
C_{iss} C_{oss} C_{rss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz	5800	pF	
		570	pF	
		30	pF	
t_{d(on)} t_r t_{d(off)} t_f	V _{GS} = 10 V, V _{DS} = 0.5 V _{DSS} , I _D = I _T R _G = 2 Ω (External)	30	ns	
		25	ns	
		80	ns	
		22	ns	
Q_{g(on)} Q_{gs} Q_{gd}	V _{GS} = 10 V, V _{DS} = 0.5 V _{DSS} , I _D = I _T	102	nC	
		34	nC	
		36	nC	
R_{thJC}			0.6 °C/W	
R_{thCS}		0.15		°C/W

Note 1: Test current I_T = 18 A

Source-Drain Diode

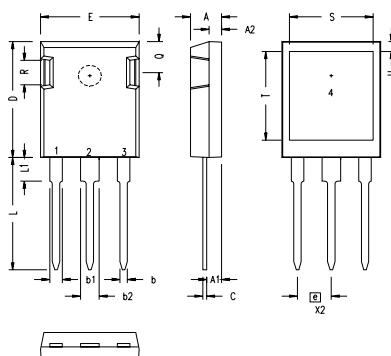
Characteristic Values

(T_J = 25°C, unless otherwise specified)

Min. Typ. Max.

I_s	V _{GS} = 0 V		36	A
I_{SM}	Repetitive		80	A
V_{SD}	I _F = I _s , V _{GS} = 0 V, Pulse test, t ≤ 300 μs, duty cycle d ≤ 2 %		1.5	V
t_{rr} Q_{RM}	I _F = 25A, -di/dt = 100 A/μs V _R = 100V, V _{GS} = 0 V		200	ns
			0.8	μC
			6.0	A

ISOPLUS247 (IXFR) Outline

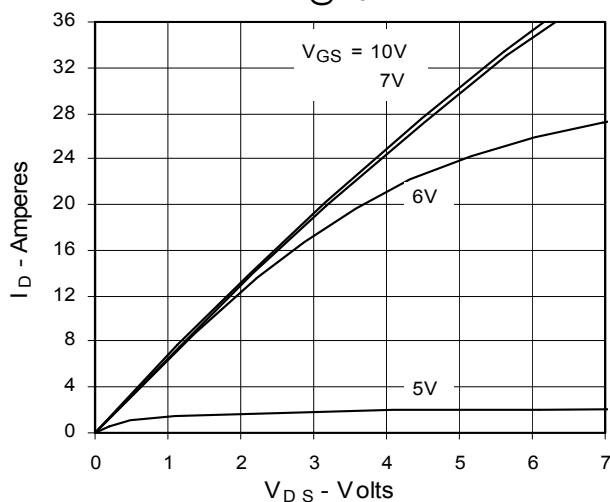


SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.190	.205	4.83	5.21
A1	.090	.100	2.29	2.54
A2	.075	.085	1.91	2.16
b	.045	.055	1.14	1.40
b1	.075	.084	1.91	2.13
b2	.115	.123	2.92	3.12
C	.024	.031	0.61	0.80
D	.819	.840	20.80	21.34
E	.620	.635	15.75	16.13
e	.215 BSC		5.45 BSC	
L	.780	.800	19.81	20.32
L1	.150	.170	3.81	4.32
Q	.220	.244	5.59	6.20
R	.170	.190	4.32	4.83
S	.520	.540	13.21	13.72
T	.620	.640	15.75	16.26
U	.065	.080	1.65	2.03

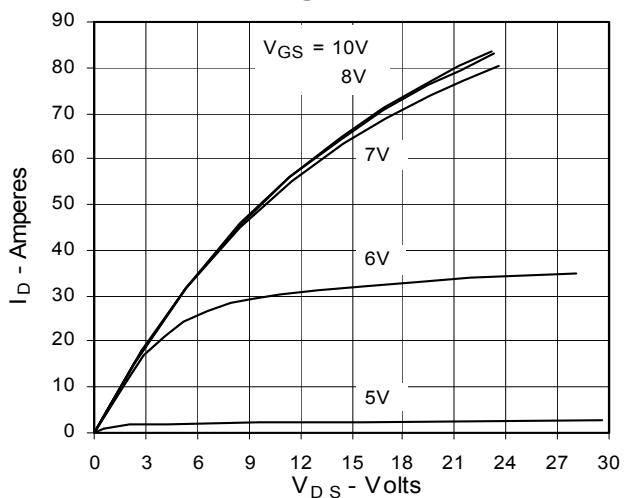
- 1 – GATE
2 – DRAIN (COLLECTOR)
3 – SOURCE (EMITTER)
4 – NO CONNECTION

NOTE: This drawing will meet all dimensions requirement of JEDEC outline TO-247AD except screw hole.

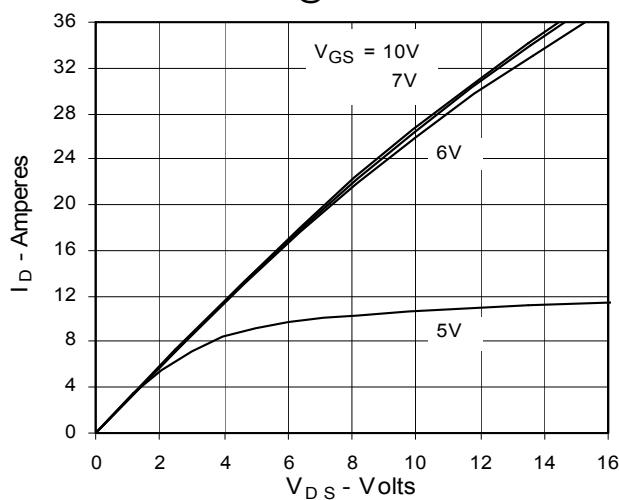
**Fig. 1. Output Characteristics
@ 25°C**



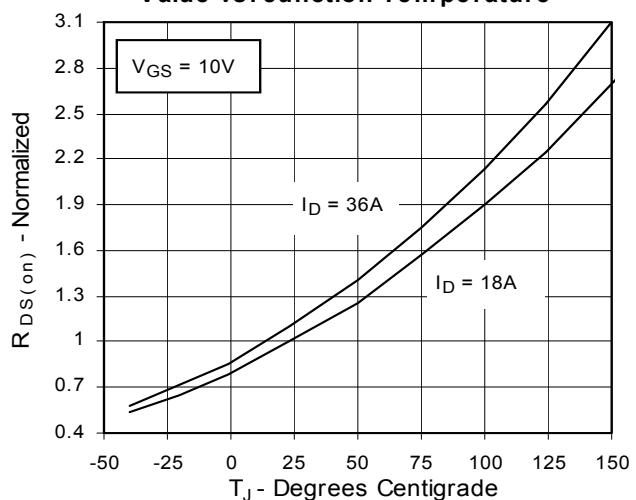
**Fig. 2. Extended Output Characteristics
@ 25°C**



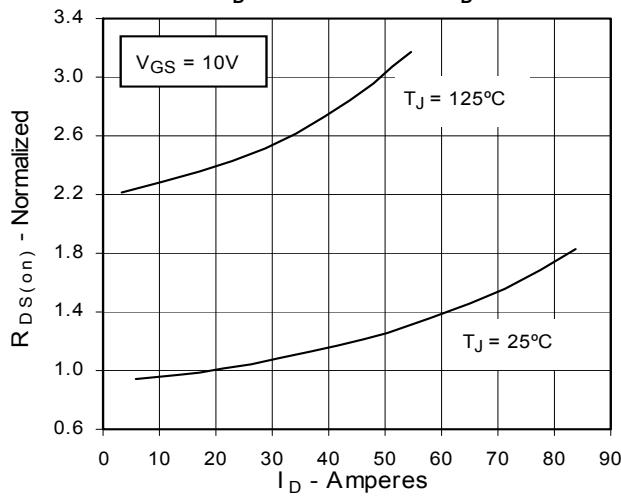
**Fig. 3. Output Characteristics
@ 125°C**



**Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 18A$
Value vs. Junction Temperature**



**Fig. 5. $R_{DS(on)}$ Normalized to
 $I_D = 18A$ Value vs. I_D**



**Fig. 6. Drain Current vs. Case
Temperature**

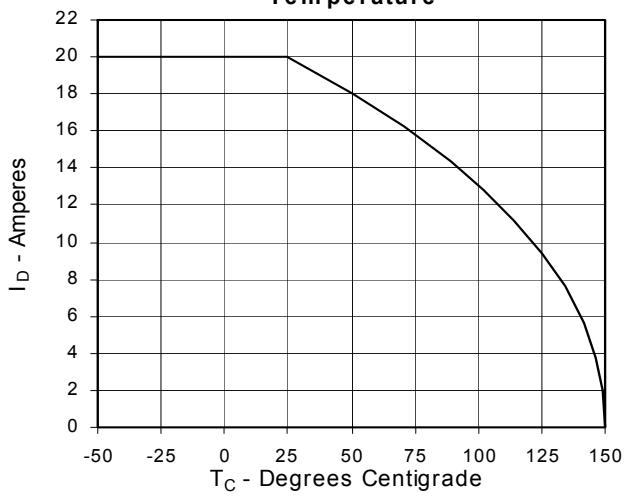
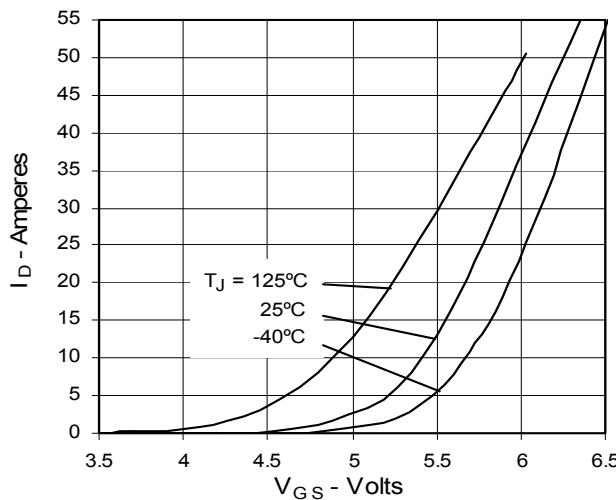
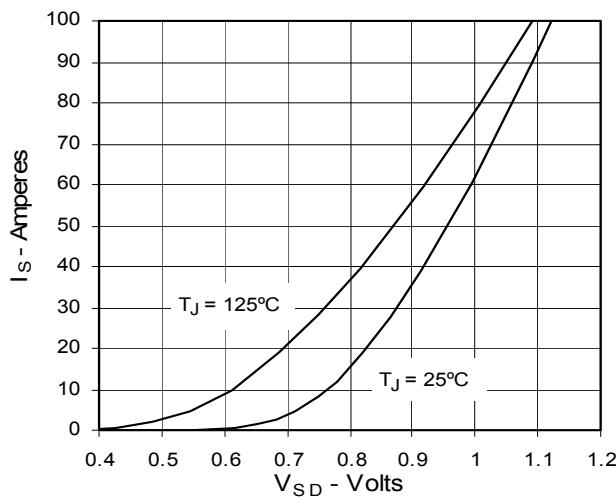
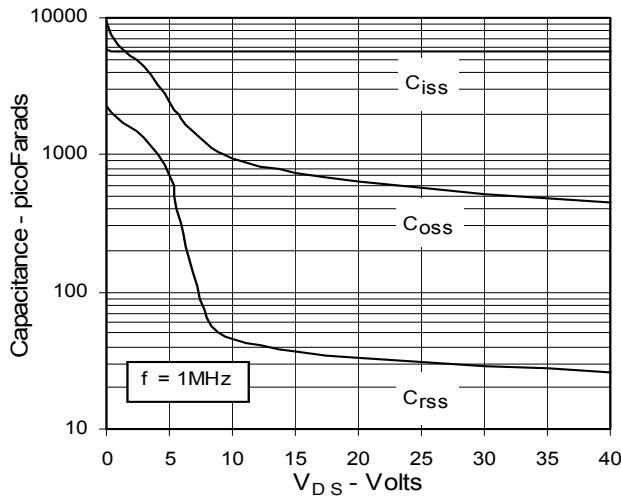
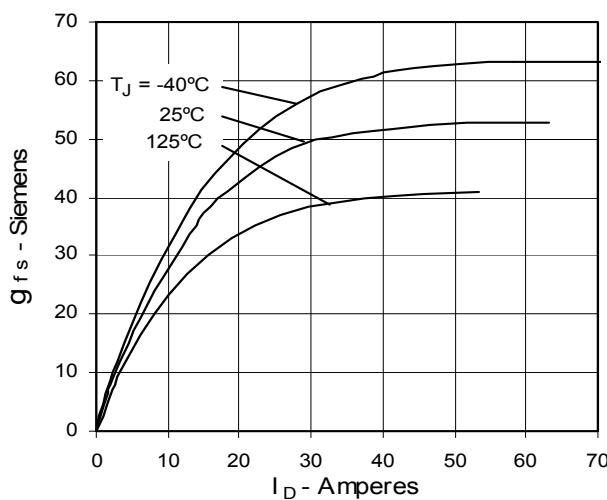
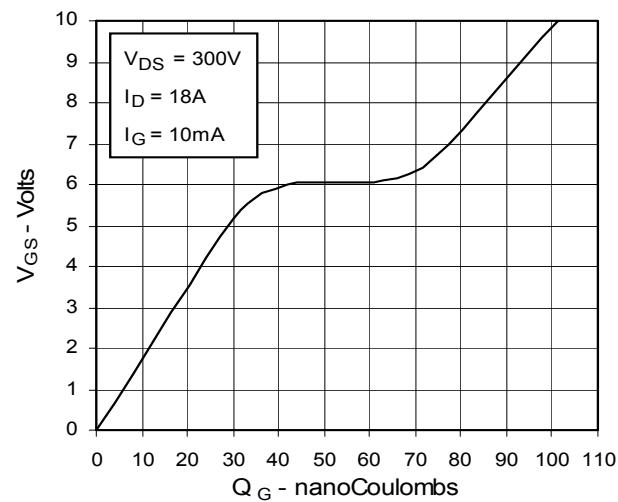
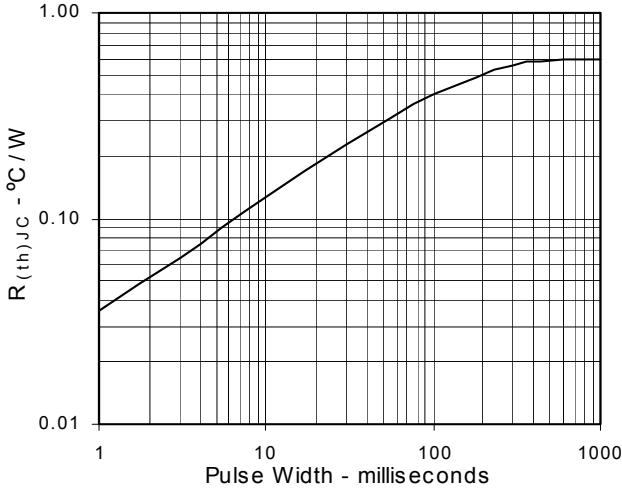


Fig. 7. Input Admittance**Fig. 9. Source Current vs. Source-To-Drain Voltage****Fig. 11. Capacitance****Fig. 8. Transconductance****Fig. 10. Gate Charge****Fig. 12. Maximum Transient Thermal Resistance**



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[DMN1006UCA6-7](#) [DMN16M9UCA6-7](#)